



The **DCRG3-080302** annular piezoelectric disc has an outer diameter of 8.3 mm and an inner diameter of 3.0 mm. It is composed of a series of laminated piezoelectric ceramic layers, each with screen-printed electrodes. The layers are bonded into a single unit through warm isostatic pressing. It can achieve a displacement of up to 2.6  $\mu$ m. The red wire of the electrode serves as the positive terminal (+), and the black wire is the negative terminal (-).



DCRG3-080302

# **Performance Parameters**

Drive Voltage Range	-30~150 V	Capacitance	550nF ± 15%
Displacement (Free Stroke) at 150 V	2.6 μm ± 15%	Dissipation Factor	<2.0%
Hysteresis	<15%	Resonant Frequency	515kHZ
Stiffness	690 N/μm	Blocking Force at 150 V	1800N
Curie Temperature	230 °C	Operating Temperature	-25 ~ 130 °C
Product Size	Outside diameter : 8.0mm	Outer Dimensions	Outside diameter : $8.3 \pm 0.1$ mm
	Inside diameter : 3.0mm		Inside diameter : $3.0 \pm 0.1$ mm
	thickness : 2.0mm		thickness: $2.0 \pm 0.05$ mm

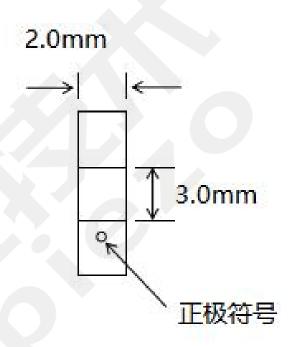
- All specifications are quoted at 25°C, unless otherwise stated.
- The displacement may vary slightly for different loads, and the maximum displacement

occurs when used with the recommended load.

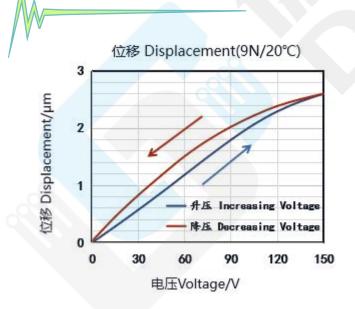


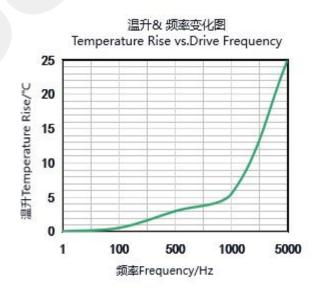


# Product Size Φ8.3mm Φ3.0mm



# **Performance Curve**





• These temperature rises were measured after applying a sine-wave drive voltage ranging from 0 to 150V at the specified frequency for 10 minutes.





# **Matters Needing Attention**

### 1. Storage Conditions & Precautions:

Temperature: <50 °C, Humidity: <40%Rh. Avoid impact and compression. Store in vacuum-sealed bags for long-term preservation. When not in use, connect to a resistive discharge ( $\geq$ 100k $\Omega$ ) or short-circuit (for low-capacitance ceramics).

### 2. Operating Conditions & Precautions:

Temperature: Maximum operating temperature  $\leq 130^{\circ}$ C (preferably  $< 60^{\circ}$ C). Add heat dissipation measures if temperature exceeds  $80^{\circ}$ C.

Humidity: <50%Rh. In high-humidity environments, preheat at low voltage before use to avoid creepage discharge.

Dust Avoidance: Dust adhesion on ceramic surfaces may reduce insulation resistance.

Clearance: Maintain a gap >1.6mm between ceramics and other conductors.

Safety: Do not immerse piezoelectric stacks in organic solvents or expose to flammable gases/liquids.

# 3. Assembly Precautions:

Polarity: Red wire = positive (+), black wire = negative (-). Reverse polarity may cause mechanical failure.

Handling: Handle with care to avoid impact. Wear gloves to prevent oil contamination.

Fit Tolerance: Assemble with clearance fit first, then tighten. Avoid interference fit to prevent ceramic compression.

Electrostatic Protection: Maintain >1.6mm gap between ceramics and metal parts to avoid static discharge.

Adhesive Bonding: Ensure flat bonding surfaces and remove excess glue to minimize contamination.

Soldering: Limit contact time under high temperature to <1 second to protect ceramics and coatings.

High-Temperature Assembly: Control temperature <120  $^{\circ}$ C to prevent depolarization, adhesive failure, or coating damage.

## 4. Preload Instructions:

Load Application: Apply external load to the center of the stack or distribute uniformly on the mounting surface. Ensure contact surfaces are flat and smooth.

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Force Direction: Piezoelectric stacks can only withstand axial forces. Shear or torsional forces may cause mechanical failure.

Preload Force: Preload should not exceed 40% of maximum blocking force, and its direction must align with the motion axis to minimize shear stress.

